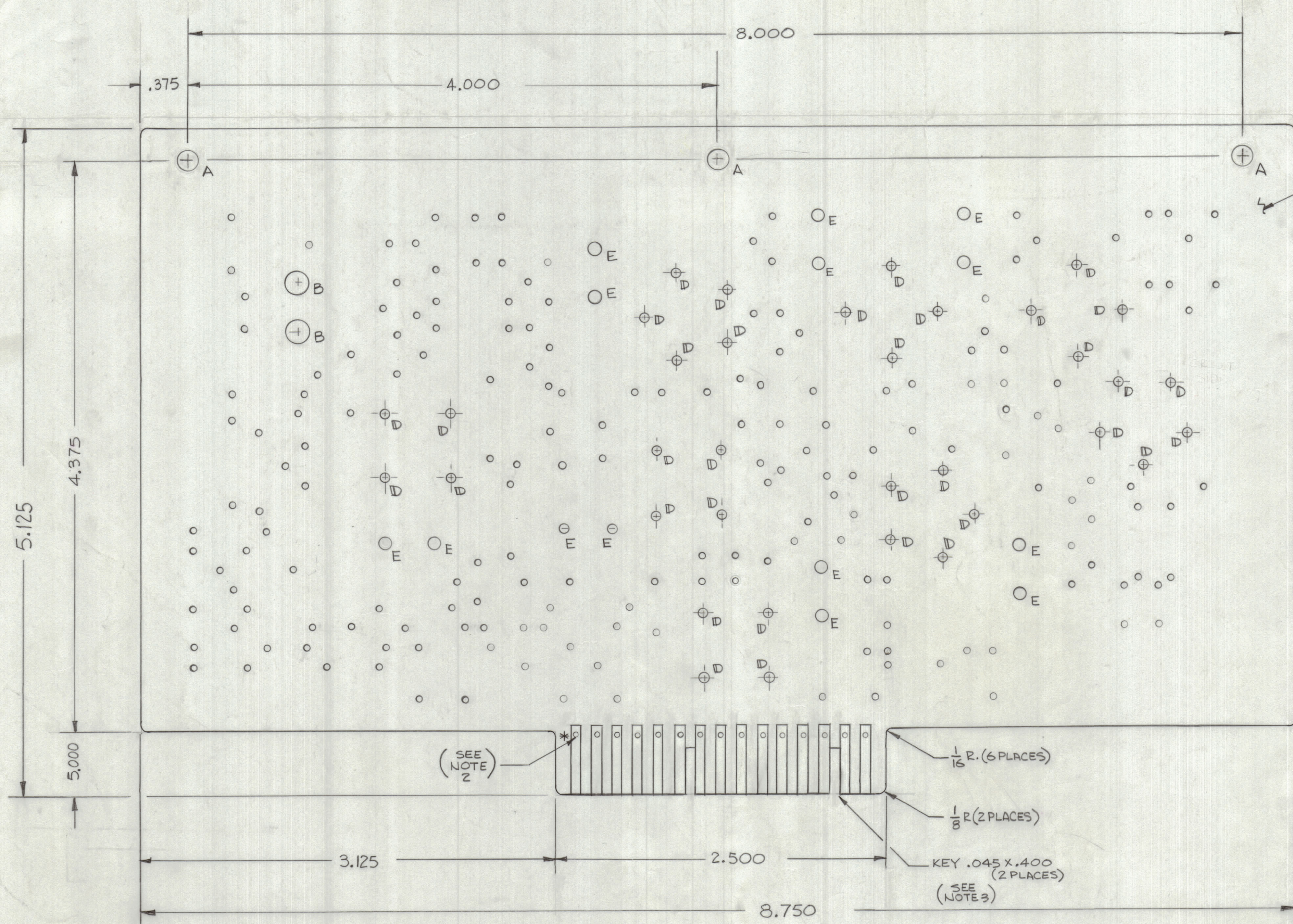


REVISIONS						
ZONE	BY	DESCRIPTION	DATE	E.M.N. NO.	DRAFT	CHKD
X		EXP. RELEASE	5-29-65	1	MP	
X1		SEE SHEET ①	5-29-65	2	MP	
Ø		ORIGINAL RELEASE FOR PRODUCTION	5-29-65	3	MP	



- FABRICATION NOTES
- MATERIAL THICKNESS .062 ± .0075 AS PER 3.2 13.2.2
 - * .040 DIA. PLATED THRU HOLES. TO BE LOCATED IN THE CENTER OF EACH FINGER CONTACT .050 AWAY FROM THE MAIN BODY OF BOARD.
 - THE PRINTED CIRCUIT BOARDS SHALL BE KEYED WITH SLOTS .050-.070 WIDE & .400 HIGH LOCATED BETWEEN FINGER CONTACTS 6 & 7, 13, 14 AS VIEWED FROM COMPONENT SIDE OF BOARD.
 - EDGE BOARD CONNECTOR (FINGER) SHALL BE GOLD PLATED 10.1 CONDUCTIVE PATTERN SHALL BE SOLDER COATED (PP13.3 & PP13.3.1)
 - HOLES TO BE PLATED THRU AS PER (PP11.4)
 - KEY SLOTS TO BE DEBURRED.
 - FOR SPARE PARTS USE ON MODEL LFSB-1 SERIAL NO. 16336 THRU 16361, BOARD THICKNESS MUST BE .093 (3/32)

HOLE	DESCRIPTION	REQ
A	11/64 DIA.	3
B	.166 DIA.	2
D	.062 DIA.	35
E	.096 DIA.	14
	UNMARKED HOLES .040 DIA	188

REQ'D.	ITEM	PART NUMBER	DESCRIPTION	SYMBOL
LIST OF MATERIAL				
MATERIAL		THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK		
FINISH		TITLE PRINTED CIRCUIT BOARD		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES		DRAWN	DATE	FINAL APPROVAL
CHECKED		DATE	DATE	DATE
ELECT. DES.		DATE	DATE	DATE
MECH. DES.		DATE	DATE	DATE

QTY./UNIT	MODEL USED ON	ASSY. NO.
SCALE 2:1	LFSB-1	A3742

NOTES

THE CONTENTS OF THIS DRAWING ARE THE EXCLUSIVE PROPERTY OF THE TECHNICAL MATERIEL CORP. ITS UNAUTHORIZED USE OR REPRODUCTION IN WHOLE OR IN PART IS STRICTLY FORBIDDEN.

DECIMALS: .X ± .05, .XX ± .01, .XXX ± .005
 FRACTIONS: ± 1/64
 ANGLES: ± 0° 30'

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